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SEP 21 2004

Application No.: 10/655,806

Docket No: JCLA11376

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: McDonald, Shanteses L.

Group Art Unit: 3723

In re PATENT APPLICATION of

Applicants : Tsai et al.

Serial No. : 10/655,806

Filed : 09/04/2003

For : POLISHING PAD AND METHOD )  
OF POLISHING WAFER )AMENDMENT

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. JCLA11376).

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

The Office Action mailed on July 27, 2004 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

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